



SIDING PREPARATION TYPICAL DETAIL

NOTE:  
LEAD PANELS SHALL BE CONSTRUCTED FROM SINGLE UNPIERCED SHEET. FREE OF OXIDE INCLUSIONS, FISSURES, VOIDS AND ALL OTHER DETRIMENTAL DEFECTS. MATERIAL SHALL BE LEAD GRADE "C" TO COMPLY WITH FEDERAL SPECIFICATION-QQ201. HUTCH SHALL MEET ALL APPLICABLE FEDERAL, STATE AND LOCAL RADIATION GUIDE LINES: NBS HANDBOOK 111 AND 114, ANS N43.2 AND DOE ORDER 5480.11.

METAL HAND STAMP "12" THIS SIDE, IN .50 [12.70] HIGH CHARACTERS NEAR CENTER OF PANEL.

ITEM	SYMBOL	QUANTITY	DESCRIPTION	MATERIAL / SPEC	REV
<b>PARTS LIST</b>					
A1943802			<b>ARGONNE NATIONAL LABORATORY</b>		
<b>ADVANCED PHOTON SOURCE</b>					
HO BLANK MODULE 1/2"					
REV	DATE	BY	CHKD	APP'D	DESCRIPTION
01	6/9/94	C. SMITH	D. SHU		INITIAL DESIGN
02	9/30/99	T. KUZAY	T. KUZAY		PROJECT MOD
03	16/10/09	SANCHEZ/SMITH			REVISIONS
04	6/10/09	T. SANCHEZ			REVISIONS

REV	DATE	BY	CHKD	APP'D	DESCRIPTION
02		JC	TS		CHANGE TO SIZE-D, REARRANGED DWG. TO FIT SIZE-BC
01		JSP	TS		ADDED 4" X 12" CUTOUT, ADDED STAMP